

# 2017-2022 Japan Die Bonder Equipment Market Report (Status and Outlook)

<https://marketpublishers.com/r/2746E31529BEN.html>

Date: July 2017

Pages: 118

Price: US\$ 3,360.00 (Single User License)

ID: 2746E31529BEN

## Abstracts

The report requires updating with new data and is sent in 48 hours after order is placed.

The Die Bonder Equipment market size will be XX million (USD) in 2022 in Japan, from the XX million (USD) in 2016, with a CAGR (Compound Annual Growth Rate) XX% from 2016 to 2022.

In Japan market, the top players include

Besi

ASM Pacific Technology (ASMPT)

Kulicke & Soffa

Palomar Technologies

Shinkawa

DIAS Automation

Toray Engineering

Panasonic

FASFORD TECHNOLOGY

West-Bond

Hybond

This report with sales, revenue and market share for each type, split by product types/category, covering

Fully Automatic

Semi-Automatic

Manual

This report focuses on sales, market share and growth rate of Die Bonder Equipment in each application, split by applications/end use industries, covers

Integrated Device Manufacturers (IDMs)

Outsourced Semiconductor Assembly and Test (OSAT)

## Contents

### **1 DIE BONDER EQUIPMENT MARKET OVERVIEW**

- 1.1 Product Overview and Scope of Die Bonder Equipment
- 1.2 Die Bonder Equipment Market Segment by Types
  - 1.2.1 Japan Die Bonder Equipment Sales Present Situation and Outlook by Types (2012-2022)
  - 1.2.2 Japan Die Bonder Equipment Sales Market Share by Types in 2016
  - 1.2.3 Fully Automatic
  - 1.2.4 Semi-Automatic  
Manual
- 1.3 Japan Die Bonder Equipment Market Segment by Applications/End Use Industries
  - 1.3.1 Japan Die Bonder Equipment Sales Present Situation and Outlook by Applications/End Industrials (2012-2022)
  - 1.3.2 Japan Die Bonder Equipment Sales Market Share by Applications/End Industrials in 2016
  - 1.3.3 Integrated Device Manufacturers (IDMs)  
Outsourced Semiconductor Assembly and Test (OSAT)
- 1.4 Japan Die Bonder Equipment Overview and Market Size (Value) (2012-2022)
  - 1.4.1 Japan Market Die Bonder Equipment Overview
  - 1.4.2 Japan Die Bonder Equipment Market Size (Value and Volume) Status and Forecast (2012-2022)

### **2 JAPAN DIE BONDER EQUIPMENT SALES, REVENUE (VALUE) AND MARKET SHARE BY PLAYERS/MANUFACTURERS**

- 2.1 Japan Die Bonder Equipment Sales and Market Share (2012-2017) by Vendors/Manufacturers
- 2.2 Japan Die Bonder Equipment Revenue and Market Share by Vendors (2012-2017)
- 2.3 Japan Die Bonder Equipment Average Price by Vendors in 2016
- 2.4 Japan Die Bonder Equipment Manufacturing Base Distribution, Sales Area, Product Types by Vendors
- 2.5 Die Bonder Equipment Market Competitive Situation and Trends
  - 2.5.1 Die Bonder Equipment Market Concentration Rate
  - 2.5.2 Die Bonder Equipment Market Share of Top 3 and Top 5 Vendors
  - 2.5.3 Mergers & Acquisitions, Expansion

### **3 JAPAN DIE BONDER EQUIPMENT SALES, REVENUE (VALUE) BY TYPE AND**

## **APPLICATION (2012-2017)**

3.1 Japan Die Bonder Equipment Sales, Revenue, Market Share and Price by Type (2012-2017)

3.1.1 Japan Die Bonder Equipment Sales and Market Share by Type (2012-2017)

3.1.2 Japan Die Bonder Equipment Revenue and Market Share by Type (2012-2017)

3.1.3 Japan Die Bonder Equipment Price by Type (2012-2017)

3.2 Japan Die Bonder Equipment Sales and Market Share by Application (2012-2017)

3.3 Japan Market Die Bonder Equipment Sales, Revenue (Million USD), Price and Gross Margin (2012-2017)

## **4 JAPAN DIE BONDER EQUIPMENT VENDORS/MANUFACTURERS PROFILES AND SALES DATA**

4.1 Besi

4.1.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.1.2 Die Bonder Equipment Product Types, Application and Specification

4.1.2.1 Type

4.1.2.2 Type

4.1.3 Besi Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

4.1.4 Main Business/Business Overview

4.2 ASM Pacific Technology (ASMPT)

4.2.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.2.2 Die Bonder Equipment Product Types, Application and Specification

4.2.2.1 Type

4.2.2.2 Type

4.2.3 ASM Pacific Technology (ASMPT) Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

4.2.4 Main Business/Business Overview

4.3 Kulicke & Soffa

4.3.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.3.2 Die Bonder Equipment Product Types, Application and Specification

4.3.2.1 Type

4.3.2.2 Type

4.3.3 Kulicke & Soffa Die Bonder Equipment Sales, Revenue, Price and Gross Margin

(2012-2017)

4.3.4 Main Business/Business Overview

4.4 Palomar Technologies

4.4.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.4.2 Die Bonder Equipment Product Types, Application and Specification

4.4.2.1 Type

4.4.2.2 Type

4.4.3 Palomar Technologies Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

4.4.4 Main Business/Business Overview

4.5 Shinkawa

4.5.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.5.2 Die Bonder Equipment Product Types, Application and Specification

4.5.2.1 Type

4.5.2.2 Type

4.5.3 Shinkawa Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

4.5.4 Main Business/Business Overview

4.6 DIAS Automation

4.6.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.6.2 Die Bonder Equipment Product Types, Application and Specification

4.6.2.1 Type

4.6.2.2 Type

4.6.3 DIAS Automation Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

4.6.4 Main Business/Business Overview

4.7 Toray Engineering

4.7.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors

4.7.2 Die Bonder Equipment Product Types, Application and Specification

4.7.2.1 Type

4.7.2.2 Type

4.7.3 Toray Engineering Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

4.7.4 Main Business/Business Overview

4.8 Panasonic

- 4.8.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors
- 4.8.2 Die Bonder Equipment Product Types, Application and Specification
  - 4.8.2.1 Type
  - 4.8.2.2 Type
- 4.8.3 Panasonic Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)
- 4.8.4 Main Business/Business Overview
- 4.9 FASFORD TECHNOLOGY
- 4.9.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors
- 4.9.2 Die Bonder Equipment Product Types, Application and Specification
  - 9.9.2.1 Type
  - 9.9.2.2 Type
- 4.9.3 FASFORD TECHNOLOGY Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)
- 4.9.4 Main Business/Business Overview
- 4.10 West-Bond
- 4.10.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors
- 4.10.2 Die Bonder Equipment Product Types, Application and Specification
  - 4.10.2.1 Type
  - 4.10.2.2 Type
- 4.10.3 West-Bond Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)
- 4.10.4 Main Business/Business Overview
- 4.11 Hybond
- 4.11.1 Company Basic Information, Manufacturing Base, Sales Area and Its Competitors
- 4.11.2 Die Bonder Equipment Product Types, Application and Specification
  - 4.11.2.1 Type
  - 4.11.2.2 Type
- 4.11.3 Hybond Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)
- 4.11.4 Main Business/Business Overview

## **5 PRODUCTION COST ANALYSIS OF DIE BONDER EQUIPMENT**

### **5.1 Main Raw Materials of Die Bonder Equipment**

- 5.1.1 List of Die Bonder Equipment Main Raw Materials
- 5.1.2 Die Bonder Equipment Main Raw Materials Price Analysis
- 5.1.3 Die Bonder Equipment Raw Materials Major Suppliers
- 5.1.4 Die Bonder Equipment Main Raw Materials Market Concentration Rate
- 5.2 Production Cost Structure of Die Bonder Equipment
  - 5.2.1 Raw Materials
  - 5.2.2 Labor Cost
  - 5.2.3 Production Expenses
- 5.3 Die Bonder Equipment Manufacturing Process/Method

## **6 VALUE CHAIN, PURCHASING STRATEGY AND DOWNSTREAM BUYERS**

- 6.1 Die Bonder Equipment Value Chain Analysis
- 6.2 Upstream Raw Materials Purchasing
- 6.3 Raw Materials Sources of Die Bonder Equipment Major Vendors in 2016
- 6.4 Downstream Buyers

## **7 MARKETING STRATEGY ANALYSIS, DISTRIBUTORS/TRADERS**

- 7.1 Sales Channel
  - 7.1.1 Direct Sales
  - 7.1.2 Indirect Sales
  - 7.1.3 Sales Channel Development Trend
- 7.2 Product Market Positioning
  - 7.2.1 Pricing Strategy
  - 7.2.2 Brand Strategy
  - 7.2.3 Target Client
- 7.3 Die Bonder Equipment Distributors/Traders List in Japan

## **8 MARKET INFLUENCES FACTORS ANALYSIS**

- 8.1 Changes from the Related Industries
- 8.2 Substitutes Threat
- 8.3 Customer Preference Change
- 8.4 Economic/Political Environmental Change
- 8.5 Upstream and Downstream Fluctuation

## **9 JAPAN DIE BONDER EQUIPMENT MARKET FORECAST (2017-2022)**

- 9.1 Japan Die Bonder Equipment Sales, Revenue and Price Forecast (2017-2022)
  - 9.1.1 Japan Die Bonder Equipment Sales and Growth Rate Forecast (2017-2022)
  - 9.1.2 Japan Die Bonder Equipment Revenue and Growth Rate Forecast (2017-2022)
  - 9.1.3 Japan Die Bonder Equipment Price Trend Forecast (2017-2022)
- 9.2 Japan Die Bonder Equipment Sales Forecast by Type (2017-2022)
- 9.3 Japan Die Bonder Equipment Sales Forecast by Application (2017-2022)

## **10 RESEARCH FINDINGS AND CONCLUSION**

## **11 APPENDIX**

- 11.1 Methodology
- 11.2 Data Source



## List Of Tables

### LIST OF TABLES AND FIGURES

Figure Picture of Die Bonder Equipment

Table Product Specifications of Die Bonder Equipment

Figure Japan Die Bonder Equipment Sales (volume) for Each Type (2012-2022)

Figure Japan Die Bonder Equipment Sales Market Share by Types in 2016

Table Types of Die Bonder Equipment

Figure Product Picture of Fully Automatic

Table Major Players of Fully Automatic

Figure Product Picture of Semi-Automatic

Table Major Players of Semi-Automatic

Figure Product Picture of Manual

Table Major Players of Manual

Figure Japan Die Bonder Equipment Sales Present Situation and Outlook by Applications (2012-2022)

Figure Japan Die Bonder Equipment Sales Market Share by Applications/End Industrials in 2016

Table Applications of Die Bonder Equipment

Figure Integrated Device Manufacturers (IDMs) Examples

Figure Outsourced Semiconductor Assembly and Test (OSAT) Examples

Figure Japan Die Bonder Equipment Revenue (Million USD) Status and Forecast (2012-2022)

Figure Japan Die Bonder Equipment Sales (Volume) Status and Forecast (2012-2022)

Table Japan Die Bonder Equipment Sales by Vendors (2012-2017)

Table Japan Die Bonder Equipment Sales Market Share (%) by Vendors (2012-2017)

Figure Japan Die Bonder Equipment Sales Share by Vendors in 2016

Figure Japan Die Bonder Equipment Sales Share by Vendors in 2017

Table Japan Die Bonder Equipment Revenue (Million USD) by Vendors (2012-2017)

Table Japan Die Bonder Equipment Revenue Market Share (%) by Vendors (2012-2017)

Figure Japan Die Bonder Equipment Revenue Share by Vendors in 2016

Figure Japan Die Bonder Equipment Revenue Share by Vendors in 2017

Figure Japan Die Bonder Equipment Average Price by Vendors in 2016

Table Japan Die Bonder Equipment Manufacturing Base Distribution and Sales Area by Vendors

Table Vendors Die Bonder Equipment Product Types

Figure Die Bonder Equipment Market Share of Top 3 Vendors

Figure Die Bonder Equipment Market Share of Top 5 Vendors

Table Japan Die Bonder Equipment Sales by Type (2012-2017)

Table Japan Die Bonder Equipment Sales and Market Share by Type (2012-2017)

Figure Japan Die Bonder Equipment Sales Market Share by Type 2016

Figure 2016 Japan Die Bonder Equipment Sales Market Share by Type

Table Japan Die Bonder Equipment Revenue (Million USD) by Type (2012-2017)

Table Japan Die Bonder Equipment Revenue Market Share by Type (2012-2017)

Figure Japan Die Bonder Equipment Revenue Market Share by Type 2016

Figure 2016 Japan Die Bonder Equipment Revenue Market Share by Type

Table Japan Die Bonder Equipment Price by Type (2012-2017)

Table Japan Die Bonder Equipment Sales by Application (2012-2017)

Table Japan Die Bonder Equipment Sales and Market Share by Application  
(2012-2017)

Figure Japan Die Bonder Equipment Sales Market Share by Application (2012-2017)

Figure 2016 Japan Die Bonder Equipment Sales Market Share by Application

Table Japan Market Die Bonder Equipment Sales, Revenue (Million USD), Price and  
Gross Margin (2012-2017)

Table Besi Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Besi Die Bonder Equipment Sales, Revenue, Price and Gross Margin  
(2012-2017)

Figure Besi Die Bonder Equipment Market Share (2012-2017)

Table ASM Pacific Technology (ASMPT) Basic Information, Manufacturing Base, Sales  
Area and Its Competitors

Table ASM Pacific Technology (ASMPT) Die Bonder Equipment Sales, Revenue, Price  
and Gross Margin (2012-2017)

Figure ASM Pacific Technology (ASMPT) Die Bonder Equipment Market Share  
(2012-2017)

Table Kulicke & Soffa Basic Information, Manufacturing Base, Sales Area and Its  
Competitors

Table Kulicke & Soffa Die Bonder Equipment Sales, Revenue, Price and Gross Margin  
(2012-2017)

Figure Kulicke & Soffa Die Bonder Equipment Market Share (2012-2017)

Table Palomar Technologies Basic Information, Manufacturing Base, Sales Area and Its  
Competitors

Table Palomar Technologies Die Bonder Equipment Sales, Revenue, Price and Gross  
Margin (2012-2017)

Figure Palomar Technologies Die Bonder Equipment Market Share (2012-2017)

Table Shinkawa Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Shinkawa Die Bonder Equipment Sales, Revenue, Price and Gross Margin

(2012-2017)

Figure Shinkawa Die Bonder Equipment Market Share (2012-2017)

Table DIAS Automation Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table DIAS Automation Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

Figure DIAS Automation Die Bonder Equipment Market Share (2012-2017)

Table Toray Engineering Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Toray Engineering Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

Figure Toray Engineering Die Bonder Equipment Market Share (2012-2017)

Table Panasonic Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Panasonic Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

Figure Panasonic Die Bonder Equipment Market Share (2012-2017)

Table FASFORD TECHNOLOGY Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table FASFORD TECHNOLOGY Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

Figure FASFORD TECHNOLOGY Die Bonder Equipment Market Share (2012-2017)

Table West-Bond Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table West-Bond Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

Figure West-Bond Die Bonder Equipment Market Share (2012-2017)

Table Hybond Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Hybond Die Bonder Equipment Sales, Revenue, Price and Gross Margin (2012-2017)

Figure Hybond Die Bonder Equipment Market Share (2012-2017)

Table Production Base and Market Concentration Rate of Raw Material

Figure Die Bonder Equipment Main Raw Materials Price Trend

Table Die Bonder Equipment Raw Materials Major Suppliers List

Figure Production Cost Structure of Die Bonder Equipment

Figure Die Bonder Equipment Manufacturing Process/Method

Figure Die Bonder Equipment Value Chain Analysis

Table Raw Materials Sources of Die Bonder Equipment Major Vendors in 2016

Table Major Buyers of Die Bonder Equipment

Table Die Bonder Equipment Distributors/Traders List in Japan  
Figure Japan Die Bonder Equipment Sales and Growth Rate Forecast (2017-2022)  
Figure Japan Die Bonder Equipment Revenue and Growth Rate Forecast (2017-2022)  
Figure Japan Die Bonder Equipment Price Trend Forecast (2017-2022)  
Table Japan Die Bonder Equipment Sales Forecast by Type (2017-2022)  
Figure Japan Die Bonder Equipment Sales Market Share Forecast by Type (2017-2022)  
Figure Japan Die Bonder Equipment Sales Market Share Forecast by Type in 2022  
Table Japan Die Bonder Equipment Sales Forecast by Application (2017-2022)  
Figure Japan Die Bonder Equipment Sales Market Share Forecast by Application (2017-2022)  
Figure Japan Die Bonder Equipment Sales Market Share Forecast by Application in 2022

## I would like to order

Product name: 2017-2022 Japan Die Bonder Equipment Market Report (Status and Outlook)

Product link: <https://marketpublishers.com/r/2746E31529BEN.html>

Price: US\$ 3,360.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

[info@marketpublishers.com](mailto:info@marketpublishers.com)

## Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/2746E31529BEN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:  
Last name:  
Email:  
Company:  
Address:  
City:  
Zip code:  
Country:  
Tel:  
Fax:  
Your message:

**\*\*All fields are required**

Customer signature \_\_\_\_\_

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970